



ON Semiconductor®

FDP5500-F085

N-Channel UltraFET Power MOSFET

55V, 80A, 7mΩ

Features

- Typ $r_{DS(on)}$ = 5.1mΩ at $V_{GS} = 10V$, $I_D = 80A$
- Typ $Q_{g(10)}$ = 114nC at $V_{GS} = 10V$
- Simulation Models
 - Temperature Compensated PSPICE and SABER™ Models
- Peak Current vs Pulse Width Curve
- UIS Rating Curve
- Qualified to AEC Q101
- RoHS Compliant

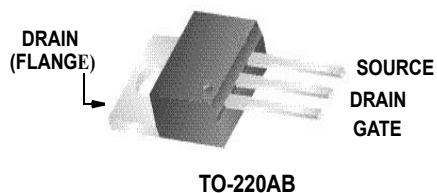
Applications

- DC Linear Mode Control
- Solenoid and Motor Control
- Switching Regulators
- Automotive Systems

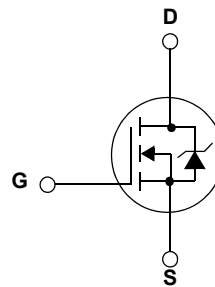


FDP5500-F085 N-Channel UltraFET Power MOSFET

Package



Symbol



MOSFET Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Ratings	Units
V_{DSS}	Drain to Source Voltage	(Note 1)	55	V
V_{DGR}	Drain to Gate Voltage ($R_{GS} = 20k\Omega$)	(Note 1)	55	V
V_{GS}	Gate to Source Voltage		± 20	V
I_D	Drain Current Continuous ($T_C < 135^\circ\text{C}$, $V_{GS} = 10\text{V}$)		80	A
	Pulsed		See Figure 4	
E_{AS}	Single Pulse Avalanche Energy	(Note 2)	860	mJ
P_D	Power Dissipation		375	W
	Derate above 25°C		2.5	W/ $^\circ\text{C}$
T_J, T_{STG}	Operating and Storage Temperature		-55 to +175	$^\circ\text{C}$
T_L	Max. Lead Temp. for Soldering (at 1.6mm from case for 10sec)		300	
T_{pkg}	Max. Package Temp. for Soldering (Package Body for 10sec)		260	

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance Junction to Case	0.4	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance Junction to Ambient TO-220AB, 1in ² copper pad area	62	$^\circ\text{C}/\text{W}$

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDP5500	FDP5500-F085	TO-220AB	Tube	N/A	50 units

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Off Characteristics

B_{VDSS}	Drain to Source Breakdown Voltage	$I_D = 250\mu\text{A}$, $V_{GS} = 0\text{V}$	55	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 50\text{V}$, $V_{GS} = 0\text{V}$	-	-	1	μA
		$V_{DS} = 45\text{V}$, $T_C = 150^\circ\text{C}$	-	-	250	
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20\text{V}$	-	-	± 100	nA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250\mu\text{A}$	2	2.8	4	V
$r_{DS(on)}$	Drain to Source On Resistance	$I_D = 80\text{A}$, $V_{GS} = 10\text{V}$	-	5.1	7	m Ω

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 25\text{V}$, $V_{GS} = 0\text{V}$, $f = 1\text{MHz}$	-	3565	-	pF	
C_{oss}	Output Capacitance		-	1310	-	pF	
C_{rss}	Reverse Transfer Capacitance		-	395	-	pF	
$Q_{g(TOT)}$	Total Gate Charge at 20V	$V_{GS} = 0$ to 20V	$V_{DD} = 30\text{V}$ $I_D = 80\text{A}$ $R_L = 0.4\Omega$ $I_g = 1.0\text{mA}$	-	207	269	nC
$Q_{g(10)}$	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V		-	114	148	nC
$Q_{g(TH)}$	Threshold Gate Charge	$V_{GS} = 0$ to 2V		-	6.6	8.6	nC
Q_{gs}	Gate to Source Gate Charge			-	17.2	-	nC
Q_{gd}	Gate to Drain "Miller" Charge			-	52	-	nC

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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Switching Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
t_{on}	Turn-On Time	$V_{DD} = 30\text{V}$, $I_D = 80\text{A}$, $R_L = 0.4\Omega$, $V_{GS} = 10\text{V}$, $R_{GS} = 2.5\Omega$	-	-	75	ns
$t_{d(on)}$	Turn-On Delay Time		-	12	-	ns
t_r	Rise Time		-	34	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	37	-	ns
t_f	Fall Time		-	23	-	ns
t_{off}	Turn-Off Time		-	-	96	ns

Drain-Source Diode Characteristics

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
V_{SD}	Source to Drain Diode Voltage	$I_{SD} = 80\text{A}$	-	0.9	1.25	V
t_{rr}	Reverse Recovery Time	$I_F = 80\text{A}$, $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	58	75	ns
Q_{rr}	Reverse Recovery Charge		-	71	92	nC

Notes:

- 1: Starting $T_J = 25^\circ\text{C}$ to 175°C .
- 2: Starting $T_J = 25^\circ\text{C}$, $L = 0.42\text{mH}$, $I_{AS} = 64\text{A}$

Typical Characteristics

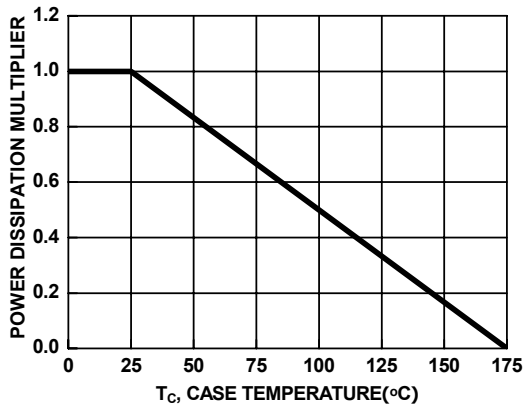


Figure 1. Normalized Power Dissipation vs Case Temperature

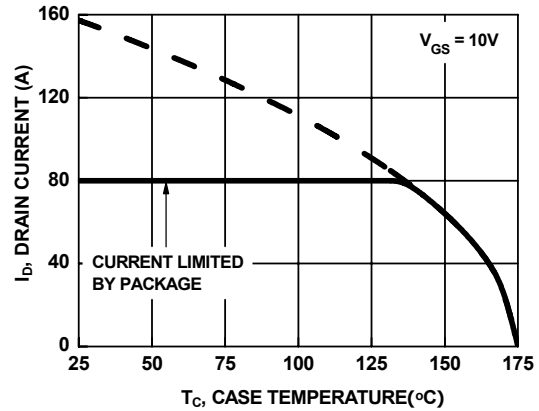


Figure 2. Maximum Continuous Drain Current vs Case Temperature

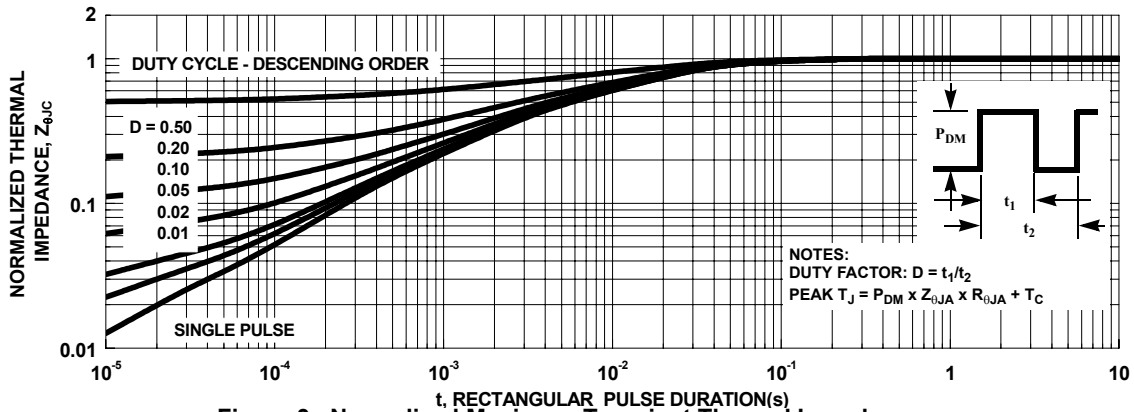


Figure 3. Normalized Maximum Transient Thermal Impedance

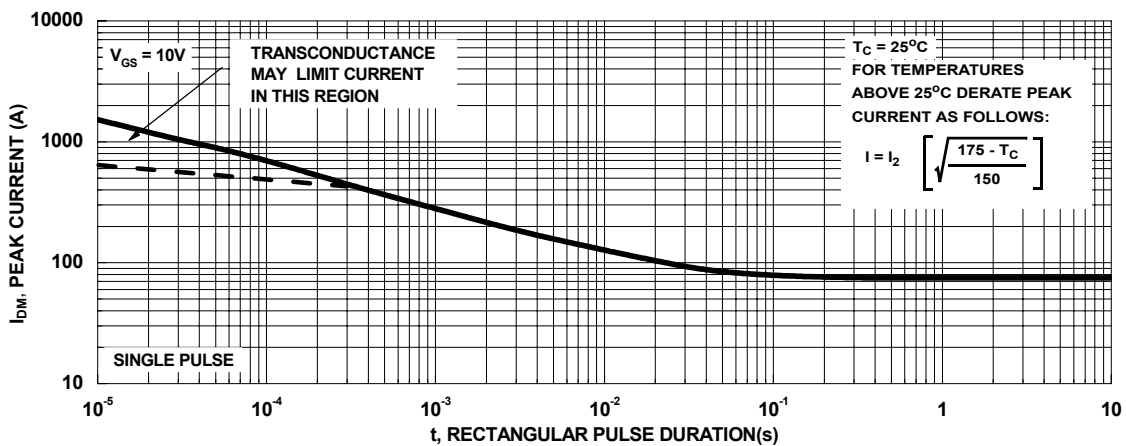


Figure 4. Peak Current Capability

Typical Characteristics

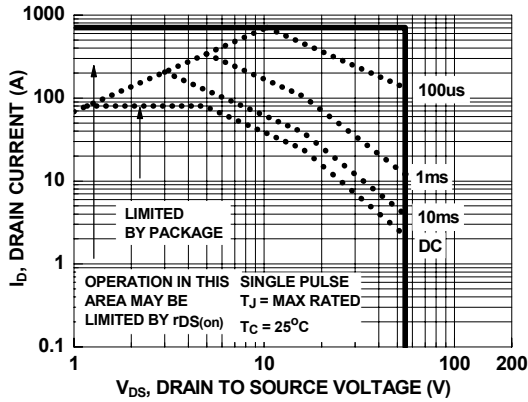
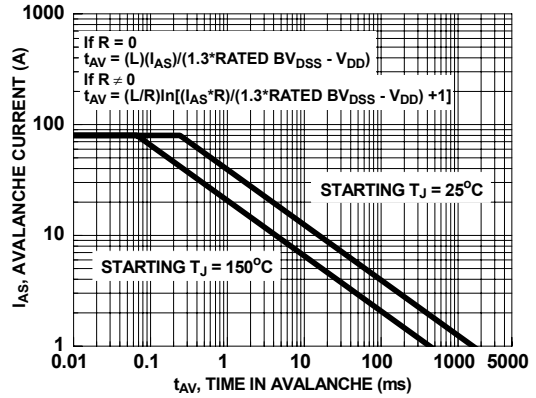


Figure 5. Forward Bias Safe Operating Area



NOTE: Refer to ON Semiconductor Application Notes AN7514 and AN7515

Figure 6. Unclamped Inductive Switching Capability

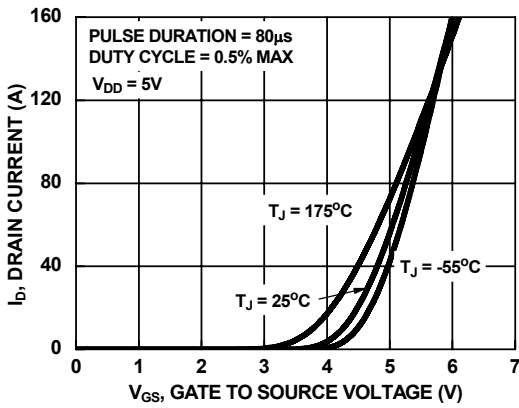


Figure 7. Transfer Characteristics

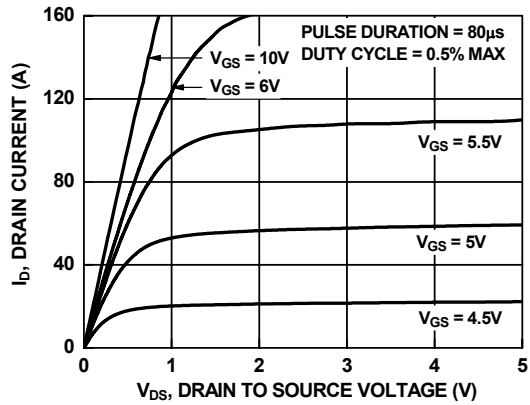


Figure 8. Saturation Characteristics

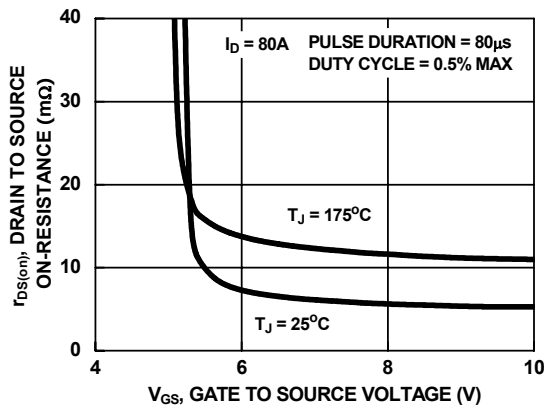


Figure 9. Drain to Source On-Resistance Variation vs Gate to Source Voltage

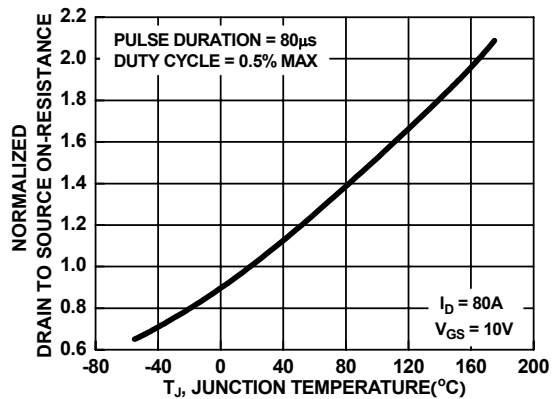


Figure 10. Normalized Drain to Source On-Resistance vs Junction Temperature

Typical Characteristics

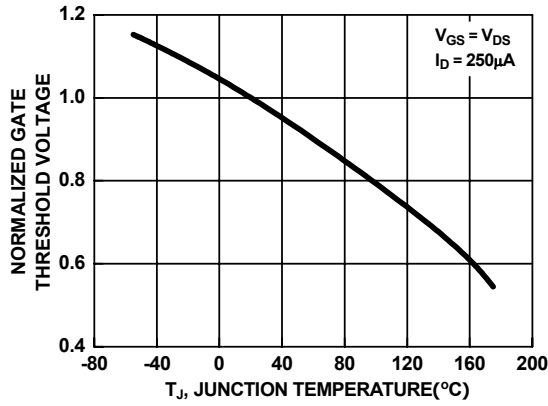


Figure 11. Normalized Gate Threshold Voltage vs Junction Temperature

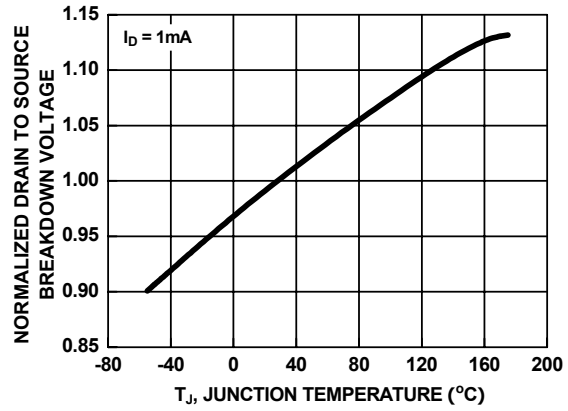


Figure 12. Normalized Drain to Source Breakdown Voltage vs Junction Temperature

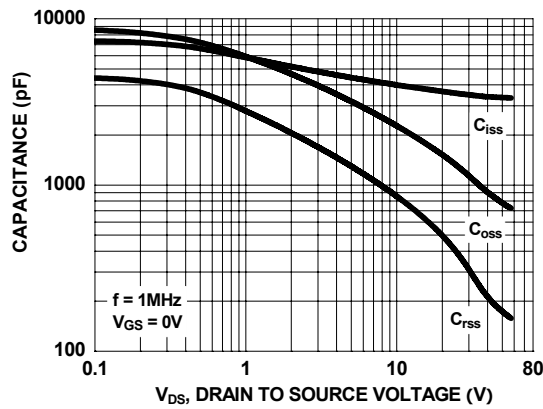


Figure 13. Capacitance vs Drain to Source Voltage

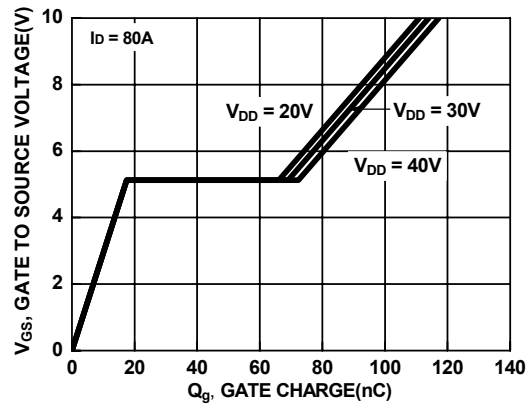


Figure 14. Gate Charge vs Gate to Source Voltage

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